

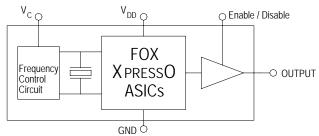
Model: FVXO-PC52 SERIES

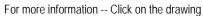
Freq: 0.75 MHz to 1.0GHz

VPECL 5 x 3.2mm 2.5V V C X O

Features

- XTREMELY Low Jitter
- Low Cost
- XPRESS Delivery
- Frequency Resolution to six decimal places
- Absolute Pull Range (APR) of ±50ppm
- -20 to +70°C or -40 to +85°C operating temperatures
- Tri-State Enable / Disable Feature
- Industry Standard Package, Footprint & Pin-Out
- Fully RoHS compliant
- Gold over Nickel Termination Finish
- Serial ID with Comprehensive Traceability





Description

The Fox XPRESSO Crystal Oscillator is a breakthrough in configurable Frequency Control Solutions. XPRESSO utilizes a family of proprietary ASICs, designed and developed by Fox, with a key focus on noise reduction technologies.

The 3rd order Delta Sigma Modulator reduces noise to the levels that are comparable to traditional Bulk Quartz and SAW oscillators. The ASICs family has ability to select the output type, input voltages, and temperature performance features.

With the XPRESS lead-time, low cost, low noise, wide frequency range, excellent ambient performance, XpressO is an excellent choice over the conventional technologies.

Finished XPRESSO parts are 100% final tested.



Rev. 04/02/2008

Need a

RoH



nade

Applications

- ANY application requiring an oscillator
- SONET
- Ethernet
- Storage Area Network
- Broadband Access
- Microprocessors / DSP / FPGA
- Industrial Controllers
- Test and Measurement Equipment
- Fiber Channel

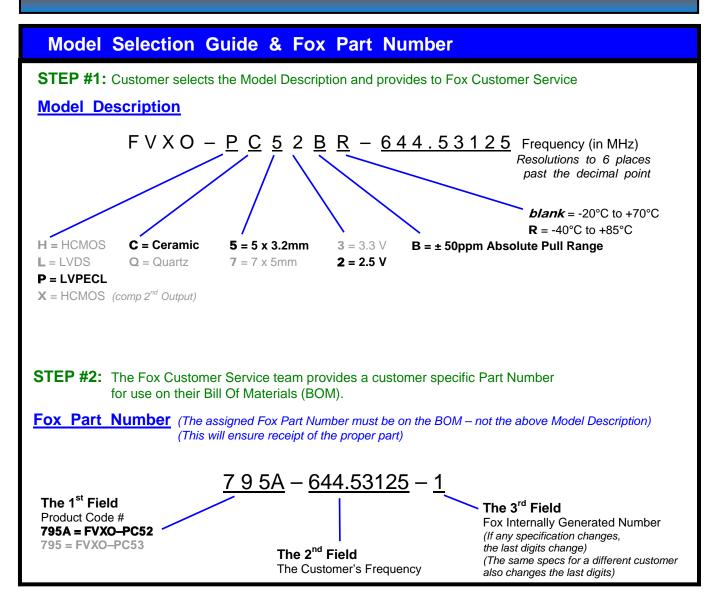
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This example, FVXO-PC52BR-644.53125 = Voltage Controlled, LVPECL Output, Ceramic, 5 x 3.2mm Package, 2.5V, ±50 PPM Absolute Pull Range, -40 to +85°C Temperature Range, at 644.53125 MHz

Absolute Maximum Ratings (Useful life may be impaired. For user guidelines only, not tested. Operation is only guaranteed for voltage and temperature specifications in Electrical Characteristics section.)					
Parameters Symbol Condition Maximum Value (unless otherwise noted)					
Input Voltage	V _{DD}		–0.5V to +5.0V		
Operating Temperature	T _{AMAX}		–55°C to +105°C		
Storage Temperature	T _{STG}		–55°C to +125°C		
Junction Temperature			150°C		
ESD Sensitivity	HBM	Human Body Model	> 1 kV		



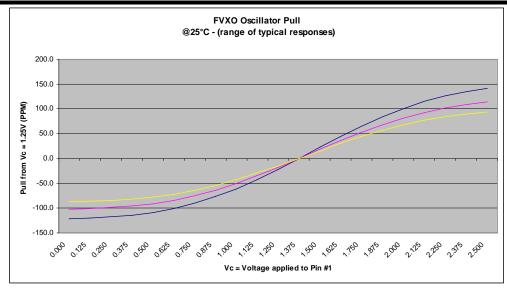
Electrical Charact	teristics		
Parameters	Symbol	Condition	Maximum Value (unless otherwise noted)
Frequency Range	Fo		0.750 MHz to 1.0 GHz
Absolute Pull Range Note 1	APR		± 50 ppm MIN
Temperature Range	T _O T _{STG}	Standard operating Optional operating Storage	-20°C to +70°C -40°C to +85°C -55°C to +125°C
Supply Voltage	V _{DD}	Standard	2.5 V ± 5%
Input Current (@ Standard Load)	I _{DD}	0.750 ~ 20.000 MHz 20.000+ ~ 220.000 MHz 220.000+ ~ 630.000 MHz 630.000+ MHz ~ 1.000 GHZ	33 mA 41 mA 63 mA 72 mA
Output Load		Standard	50 Ohms into V_{DD} -2 V_{DC} . TYP.
Start-Up Time	Ts		10 mS
Output Enable / Disable Time			100 nS
Moisture Sensitivity Level	MSL	JEDEC J-STD-20	1
Termination Finish			Au

Note 1 – Inclusive of 25°C tolerance, operating temperature range, input voltage change, load change, aging, shock and vibration.

Frequency Control (V _c) Input pin # 1					
Symbol	Condition	Maximum Value (unless otherwise noted)			
	0V to V_{DD}	40 ~ 75 ppm/V Typ ²			
L _{VC}		± 10%			
Vc		0V ~ 2.5V			
BW		10 kHz Min			
V _{CNOM}		1.25V			
	Symbol L _{VC} V _C BW	Symbol Condition 0V to V _{DD} L _{VC} V _C BW			

ed by frequency and accuracy settings.

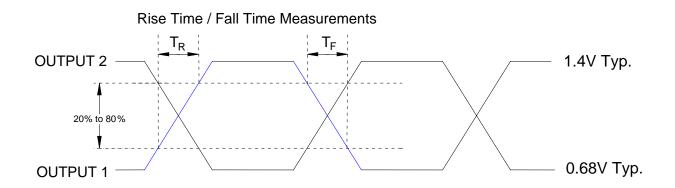
² For an example of linearity, see the graph below. (*The middle line represents the default Fox factory setting*)





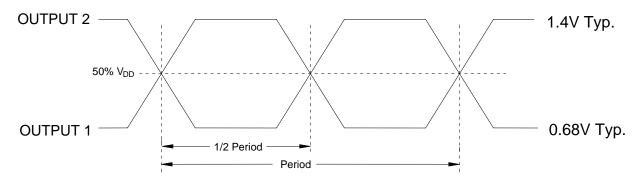


Output Wave Charac	Output Wave Characteristics					
Parameters	Symbol	Condition	Maximum Value (unless otherwise noted)			
Low Output Voltage	V _{OL}	0.75 MHz to 1.0 GHz	0.68V Typ			
High Output Voltage	V _{OH}	0.75 MHz to 1.0 GHz	1.4V Typ			
Output Symmetry (See Drawing Below)		@ 50% V _{P-P} Level	45% ~ 55%			
Output Enable (PIN # 2) Voltage	V _{IH}		≥ 70% V _{DD}			
Output Disable (PIN # 2) Voltage	VIL		$\leq 30\% V_{DD}$			
Cycle Rise Time (See Drawing Below)	T _R	20%~80% Vp-p	400 pS			
Cycle Fall Time (See Drawing Below)	T _F	80%~20% Vp-p	400 pS			



Oscillator Symmetry

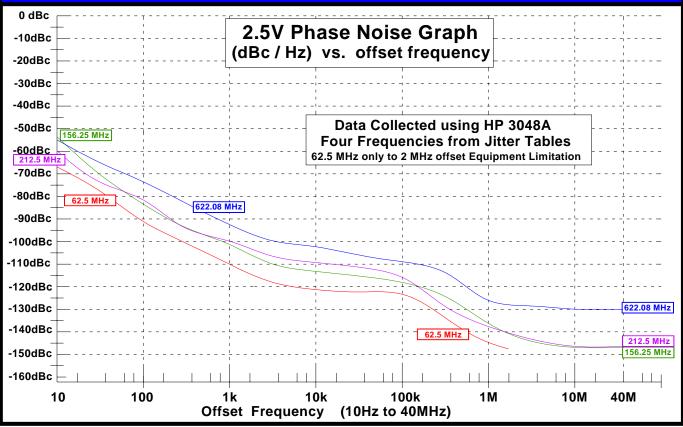
Ideally, Symmetry should be 50/50 for 1/2 period -- Other expressions are 45/55 or 55/45







Phase Noise



Jitter is frequency dependent. Below are typical values at select frequencies.

LVPECL Ph	LVPECL Phase Jitter & Time Interval Error (TIE)					
Frequency	Phase Jitter (12kHz to 20MHz)	TIE (Sigma of Jitter Distribution)	Units			
62.5 MHz	2.10	3.1	pS RMS			
156.25 MHz	1.20	3.5	pS RMS			
212.5 MHz	1.27	4.2	pS RMS			
622.08MHz	1.68	3.7	pS RMS			

Phase Jitter is integrated from HP3048 Phase Noise Measurement System; measured directly into 50 ohm input; V_{DD} = 2.5V. <u>TIE</u> was measured on LeCroy LC684 Digital Storage Scope, directly into 50 ohm input, with Amherst M1 software; V_{DD} = 2.5V. *Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)*

LVPECL Random & Deterministic Jitter Composition					
Frequency	Random (Rj) (pS RMS)	Deterministic (Dj) (pS P-P)	Total Jitter (Tj) (14 x Rj) + Dj		
62.5 MHz	1.35	10.5	30.5 pS		
156.25 MHz	1.36	10.0	29.3 pS		
212.5 MHz	1.33	11.8	30.8 pS		
622.08 MHz	1.06	8.3	23.4 pS		

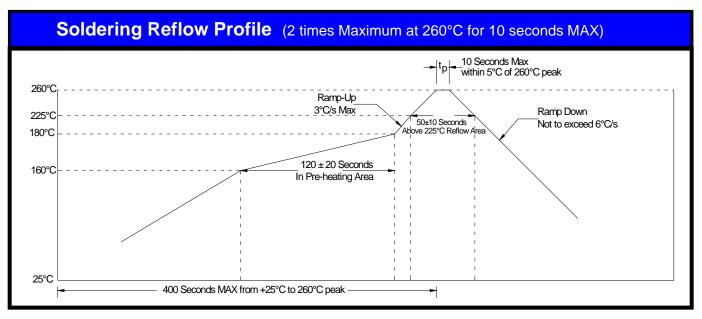
<u>**Rj and Dj**</u>, measured on LeCroy LC684 Digital Storage Scope, directly into 50 ohm input, with Amherst M1 software. *Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)*





Pin #	Name	Туре	Function
1	Vc	Control	Frequency Control by changing voltage
2	E/D ¹	Logic	Enable / Disable Control of Output (0 = Disabled)
3	GND	Ground	Electrical Ground for V _{DD}
4	Output	Output	LVPECL Oscillator Output
5	Output 2	Output	Complementary LVPECL Output
6	V _{DD} ²	Power	Power Supply Source Voltage
NOTES	¹ Includes pull-u ² Installation sho	p resistor to V _{DD} to pr uld include a 0.01µF	rovide output when the pin (2)is No Connect. bypass capacitor placed between V _{DD} power supply line noise.
	¹ Includes pull-u ² Installation sho (Pin 6)and GNI	p resistor to V _{DD} to pr uld include a 0.01µF D (Pin 3) to minimize	rovide output when the pin (2)is No Connect. bypass capacitor placed between V_{DD} power supply line noise. 0.01μ F
	¹ Includes pull-u ² Installation sho (Pin 6)and GNI	p resistor to V _{DD} to pr uld include a 0.01µF	rovide output when the pin (2)is No Connect. bypass capacitor placed between V_{DD} power supply line noise.
	¹ Includes pull-u ² Installation shor (Pin 6)and GNI	p resistor to V _{DD} to pr uld include a 0.01µF D (Pin 3) to minimize	rovide output when the pin (2)is No Connect. bypass capacitor placed between V_{DD} power supply line noise. $0.01\mu F$

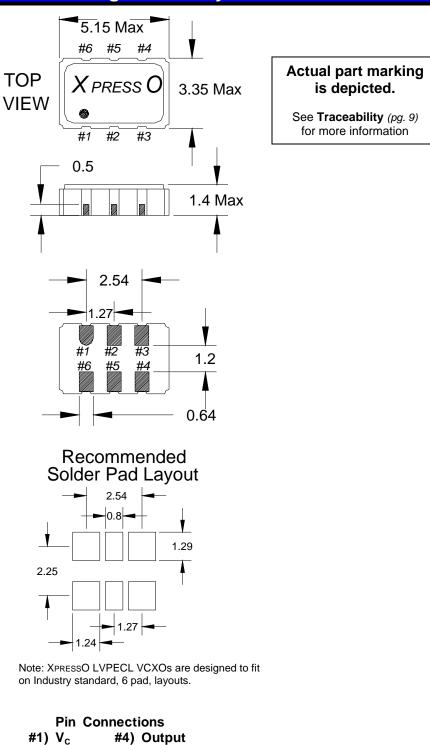
Enable / Disable Control	
Pin # 2 (state)	Output (Pin # 4, Pin # 5)
OPEN (No Connection)	ACTIVE Output
"1" Level V _{IH} ≥ 70% V _{DD}	ACTIVE Output
"0" Level $V_{IL} \le 30\% V_{DD}$	High Impedance







Mechanical Dimensional Drawing & Pad Layout



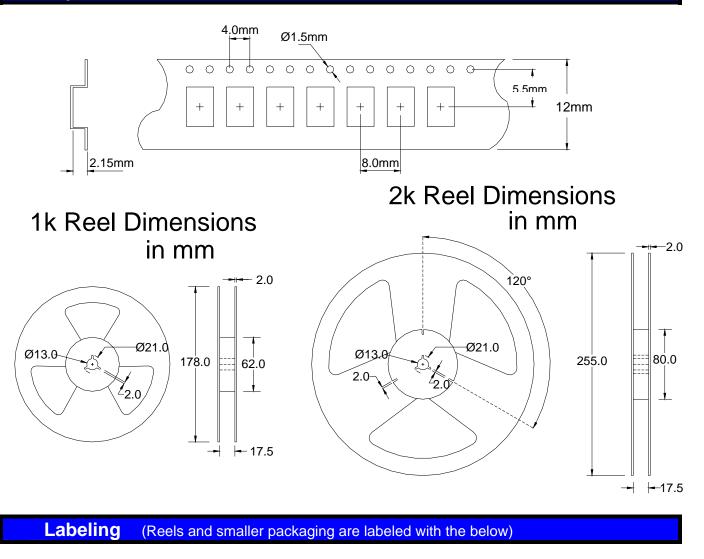
#2) E/D #5) Output 2 #3) GND #6) V_{DD}

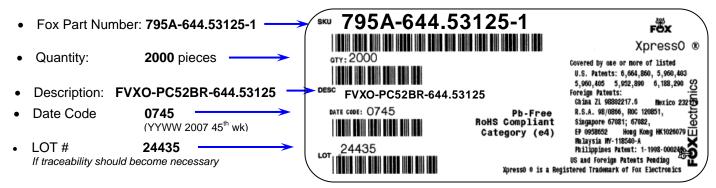
Drawing is for reference to critical specifications defined by size measurements. Certain non-critical visual attributes, such as side castellations, reference pin shape, etc. may vary





Tape and Reel Dimensions





An additional identification code is contained internally if tracking should ever be necessary





Traceability – LOT Number & Serial Identification

LOT Number

The LOT Number has direct ties to the customer purchase order. The LOT Number is marked on the "Reel" label, and also stored internally on non-volatile memory inside the XPRESSO part. XPRESSO parts that are shipped Tape and Reel, are also placed in an Electro Static Discharge (ESD) bag and will have the LOT Number labeled on the exterior of the ESD bag.

It is recommended that the XPRESSO parts remain in this ESD bag during storage for protection and identification.

If the parts become separated from the label showing the LOT Number, it can be retrieved from inside one of the parts, and the information that can be obtained is listed below:

- Customer Purchase Order Number
- Internal Fox Sales Order Number
- Dates that the XPRESSO part was shipped from the factory
- The assigned customer part number
- The specification that the part was designed for

Serial Identification

The Serial ID is the individualized information about the configuration of that particular XPRESSO part. The Serial ID is unique for each and every XPRESSO part, and can be read by special Fox equipment.

With the Serial ID, the below information can be obtained about that individual, XPRESSO part:

- Equipment that the XPRESSO part was configured on
- Raw material used to configure the XPRESSO part
- Traceability of the raw material back to the foundries manufacturing lot
- Date and Time that the part was configured
- Any optimized electrical parameters based on customer specifications
- Electrical testing of the actual completed part
- Human resource that was monitoring the configuration of the part

Fox has equipment placed at key Fox locations World Wide to read the Lot Identification and Serial Number of any XPRESSO part produced and can then obtain the information from above within 24 hours





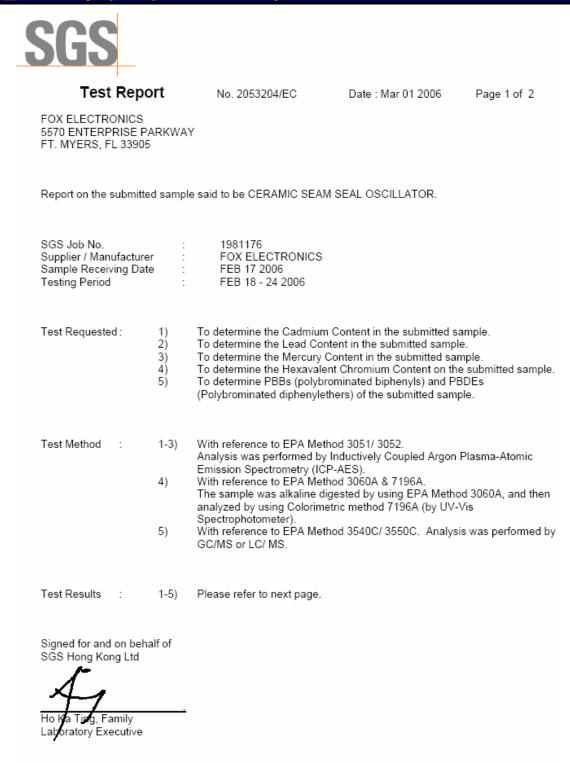
RoHS Material Declaration

	Material Name	Component	Content	Content	
			(mg)	(w t %)	(CAS Number)
Cover	Kovar	Nickel (Ni)	1.890	3.09%	7440-02-0
		Cobalt (Co)	1.113	1.82%	7440-48-4
		Iron (Fe)	3.540	5.78%	7439-89-6
Base	Ceramic	Alumina (Al ₂ O ₃)	35.484	57.98%	1344-28-1
		Silicon Oxide (SiO ₂)	1.733	2.83%	14808-60-7
		Chromium Oxide (Cr ₂ O ₃)	0.268	0.44%	1308-38-9
		Molybdenum Oxide (MoO ₂)	0.364	0.59%	18868-43-4
		Magnesium Oxide (MgO)	0.234	0.38%	1309-48-4
		Calcium Oxide (CaO)	0.253	0.41%	1305-78-8
	+ Metallization	Tungsten (W)	6.290	10.28%	7440-33-7
		Molybdenum (Mo)	0.195	0.32%	7439-98-7
	+ Nickel Plating	Nickel (Ni)	0.810	1.32%	7440-02-0
		Cobalt (Co)	0.203	0.33%	7440-48-4
	+ Gold Plating	Gold (Au)	0.281	0.46%	7440-57-5
	+Seal ring	Iron (Fe)	2.438	3.98%	7439-89-6
		Nickel (Ni)	1.309	2.14%	7440-02-0
		Cobalt (Co)	0.768	1.25%	7440-48-4
	+silver solder	Silver (Ag)	1.191	1.95%	7440-22-4
		Copper (Cu)	0.210	0.34%	7440-50-8
ΙC	ΙC	Aluminum (Al)	0.0021	0.00343%	7429-90-5
		Silicon (Si)	0.950	1.55%	7440-21-3
	Gold	Gold (Au)	0.480	0.784%	7440-57-5
	Adhesive	Silver (Ag)	0.000210	0.000343%	7440-22-4
		Ероху	0.0000700	0.0001144%	
Crystal	Crystal	Silicon Dioxide (SiO ₂)	1.170	1.91%	14808-60-7
	Electrode	Silver (Ag)	0.019	0.0310%	7440-22-4
		Nickel (Ni)	0.000159	0.000260%	7440-02-0
	Adhesive	Silver (Ag)	0.00037	0.000605%	7440-22-4
		Silicon (Si)	0.000125	0.000204%	7440-21-3
TOTAL			61.196	100.00%	





3rd Party (SGS) Material Report



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3rd Party (SGS) Material Report (continued)



Test Report

No. 2053204/EC

Date : Mar 01 2006

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Test Results

Test Item	<u>1</u>	Detection Limit
1) Cadmium (Cd)	ND	2 ppm
2) Lead (Pb)	ND	2 ppm
3) Mercury (Hg)	ND	2 ppm
 Hexavalent Chromium (Cr⁶⁺) 	ND	2 ppm

(Results shown are of the total weight of samples)

Note : ppm = mg/kg

ND = Not Detected Not detected is reported when the reading is less than detection limit value

_5)		
Flame Retardants	1	Detection Limit
Polybrominated Biphenyls (PBBs)		
Monobromobiphenyl	ND	5 ppm
Dibromobiphenyl	ND	5 ppm
Tribromobiphenyl	ND	5 ppm
Tetrabromobiphenyl	ND	5 ppm
Pentabromobiphenyl	ND	5 ppm
Hexabromobiphenyl	ND	5 ppm
Heptabromobiphenyl	ND	5 ppm
Octabromobiphenyl	ND	5 ppm
Nonabromobiphenyl	ND	5 ppm
Decabromobiphenyl	ND	5 ppm
Polybrominated Diphenylethers (PBDEs)		
Monobromodiphenyl ether	ND	5 ppm
Dibromodiphenyl ether	ND	5 ppm
Tribromodiphenyl ether	ND	5 ppm
Tetrabromodiphenyl ether	ND	5 ppm
Pentabromodiphenyl ether	ND	5 ppm
Hexabromodiphenyl ether	ND	5 ppm
Heptabromodiphenyl ether	ND	5 ppm
Octabromodiphenyl ether	ND	5 ppm
Nonabromodiphenyl ether	ND	5 ppm
Decabromodiphenyl ether	ND	5 ppm

Note : ppm = mg/kg

ND = Not Detected

Not detected is reported when the reading is less than detection limit value.

Sample Description:

1. Black Ceramic w/ Silvery, Golden Metal w/ Silvery Chips

*** End of Report ***

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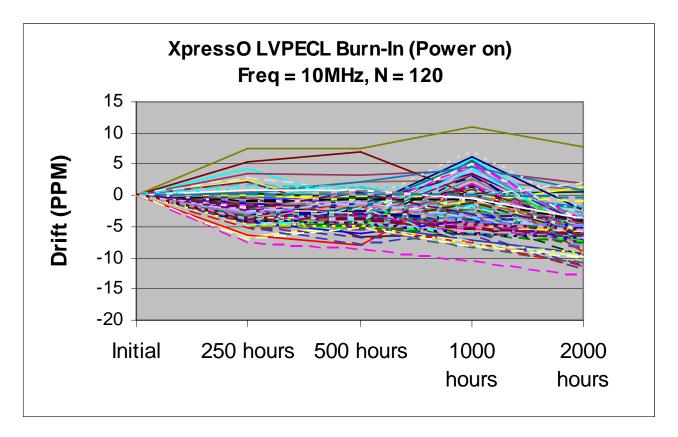


Mechanical Testing

Parameter	Test Method
Mechanical Shock	Drop from 75cm to hardwood surface – 3 times
Mechanical Vibration	10~55Hz, 1.5mm amplitude, 1 Minute Sweep 2 Hours each in 3 Directions (X, Y, Z)
High Temperature Burn-in	Under Power @ 125°C for 2000 Hours (results below)
Hermetic Seal	He pressure: 4 ±1 kgf / cm ² 2 Hour soak

2,000 Hour Burn-In

Burn-In Testing – under power 2000 Hours, 125°C







MTTF / FITS Calculations

Products are grouped together by process for MTTF calculations. (All XpressO output and package types are manufactured with the same process)

Number of Parts Tested:
Number of Failures:360 (120 of each output type: HCMOS, LVDS, LVPECL)Number of Failures:
Test Temperature:125°CNumber of Hours:
20002000

MTTF was calculated using the following formulas:

[1.] Device Hours (devhrs) = (number of devices) x (hours at elevated temperature in °K)

 $[2.] MTTF = \frac{devhrs \times af \times 2}{\chi^2}$

[3.] FITS = $\frac{1}{MTTF}$ * 10⁹

Where:

Label	Name	Formula/Value
af	Acceleration Factor	$\boldsymbol{\varrho}^{(\frac{eV}{k})\times(\frac{1}{t_1}-\frac{1}{t_2})}$
eV	Activation Energy	0.40 V
k	Bolzman's Constant	8.62 X 10⁻⁵ e <i>V</i> /ºK
t ₁		Operating Temperature (°K)
t ₂		Accelerated Temperature (°K)
Θ	Theta	Confidence Level (60% industry standard)
r	Failures	Number of failed devices
X ²	Chi-Square	statistical significance for bivariate tabular analysis [table look- up] based on assumed Θ (Theta – confidence) and number of failures (r) For zero failures (60% Confidence): $\chi^2 = 1.830$

DEVICE-HOURS = 360 x 2000 HOURS = 720,000

ACCELERATION FACTOR = $e^{(\frac{0.40}{8.625}) \times (\frac{1}{298} - \frac{1}{398})} = 49.91009$

MTTF = $\frac{720,000 \times 49.91009 \times 2}{1.833}$ = 39,209,238 Hours

Failure Rate = $\frac{1.833}{720,000 \times 49.91009 \times 2}$ = 2.55E-8

FITS = Failure Rate *1E9 = 26





Notes :

For the complete product line of *XpressO* products visit http://www.foxonline.com/xpressomain.htm

Patent Numbers: US 6,664,860, US 5,960,403, US 5,952,890; US 5,960,405; US 6,188,290; Foreign Patents: R.S.A. 98/0866, R.O.C. 120851; Singapore 67081, 67082; EP 0958652 China ZL 98802217.6, Malaysia MY-118540-A, Philippines 1-1998-000245, Hong Kong #HK1026079, Mexico #232179 US and Foreign Patents Pending XpressO[™] Fox Electronics

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The above specifications, having been carefully prepared and checked, is believed to be accurate at the time of publication; however, no responsibility is assumed by Fox Electronics for inaccuracies.

